NXP i.MX93-210 Reference Development Platform



eInfochips EIC-i.MX93-210 Reference Development Platform



About eInfochips

eInfochips is a product engineering services company offering technology consulting and product design services in multiple industry verticals like aerospace & defense, security, and surveillance, medical and healthcare, industrial and home automation, consumer electronics, and more.

As an elite design partner of NXP semiconductor, elnfochips has been selected for "Early Access Programs" for all i.MX series platforms. We have designed and developed products for a variety of global customers by leveraging our partnership with NXP.

Engineering Highlights

- 25+ Years of experience in system design
- 10 Design centers spread across India, USA, Europe, and Africa
- 500+ Products designs
- 35+ Product designs
- 15M+ Product deployments across the globe
- ISO 60601 and IEC 62304 compliant medical design processes

eInfochips EIC-i.MX93-210 Reference Development Platform

The EIC- i.MX93-210 is an RDP based on the i.MX93 application processors. The processor features a scalable Arm Ethos™-U65 microNPU Core for efficient machine learning acceleration, as well as advanced security with an integrated EdgeLock secure enclave to support edge computing. The RDP enables developers to begin creating high-performance, cost-effective, and energy-efficient machine-learning applications. Wi-Fi, Bluetooth, Gigabit Ethernet, CAN, and 3G/4G/LTE connectivity via a Mezzanine Card are all available. The kit includes preintegrated Linux, making it an excellent choice for applications such as industrial automation, smart home & intelligent appliances, smart buildings, and automotive.

Edge Computing Infotainment Smart Home Appliances AI and ML Applications Digital Signage/ Industrial HMI Machine Vision

Matter 1.0 Ready



iMX 93x Platform



Bluetooth 5.3 compliant with Bluetooth

2.1 + Enhanced Data Rate (EDR)

1x USB2.0 Host mode Only

1x 4-Lane MIPI DSI v1.2 interface

2 Lane MIPI CSI-2 v1.2 interface

1x USB2.0 with DRP

1x RGMI Interface

1x 4-Lane LVDS

1x HDMI interface (Mux)

8-bit RGB interface (Mux)

1x 4 channel current sensor

Note: This is preliminary information and subject to change without notice

Bluetooth:

USB

Ethernet

Display

Camera

Audio

Sensors

3x SAI

1x PDM

Processor

- NXP iMX935, iMX933
- Two Cortex[®]-A55 processors
- operating up to 1.7 GHz
- 64-bit Arm[®] v8.2-A architecture
- MPE with Arm® NEONTM
- Floating Point Unit (FPU) with support of the Arm[®] VFPv4-D16 architecture
- One Cortex[®]-M33 CPU operating up to 250 MHz
- NPU targets 8-bit and 16-bit integer RNN, handles 8-bit weights.

Memory and Storage

- 1x 2GB LPDDR4x RAM
- 1x 16GB eMMC 5.1
- 1x SDIO 3.0 interface
- (mux with WLAN)
- 1x SD Card 3.0 interface

Connectivity

Wi-Fi:

- AWCM276NF IEEE 802.11 a/b/g/n/ ac, 2.4/5.0 GHz
- 2x MHF4 antenna connector
- Matter 1.0 Ready

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Other

- 1x CAN Interface
- 3x UART, 4x I2C, 2x SPI, 4x ADC, GPIOs
- 1x Reset Switch, 1x ON/OFF Switch

Power Specification

- SOM: 3.8V to 5.5V (Typ. 5V)
- Carrier (Kit): 10.8V to 13.2V (Typ. 12V)

Mechanical Specification

- SOM: 65mm x 55mm
- Carrier Board: 85mm x 100mm
- **Operating System**
- Linux

Orderable Part

- EIC-i.MX9-210 Dev Kit
 - iMX93 SOM
 - iMX93 Carrier
- EIC-i.MX93-210 Multimedia Kit
- Multimedia Mezzanine board
- Display board for MIPI-DSI and LVDS
- EIC-i.MX93-210 RGB Camera Module RGB Camera board.
 - RGB Sensor Module.

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